TLP590B

TOSHIBA Photocoupler IRED & Photo-Diode Array

TLP590B

Telecommunications Unit: mm **Programmable Controllers MOS Gate Drivers MOSFET Gate Drivers** The TOSHIBA TLP590B consists of an infrared emitting diode optically coupled to a series-connected photo-diode array in a six-lead plastic DIP package. The TLP590B is suitable for MOSFET gate drivers. 7.62±0.25 • UL-recognized: UL 1577, File No.E67349 Short Current 0.25+0.10 7.85 to 8.80 Short Current Classification Туре Classification Name Marking (min) I_F C20 20 µA 20 TLP590B 10 mA 12 µA Standard 20, blank TOSHIBA 11-7A9S Note: When applying for a safety standard approval, Weight: 0.39 g (typ.) use the type name of the standard device. TLP590B(C20): TLP590B Pin Configuration (Top View)]6 1 C 2 [3 E 1: Anode(LED) 2: Cathode(LED) 3: N.C. 4: Cathode 6: Anode

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Absolute Maximum Ratings (Ta = 25°C)

	Characteristics	Symbol	Rating	Unit		
	Forward current	lF	50	mA		
	Forward current derating (Ta ≥ 25°C)	ΔI _F / °C	-0.5	mA / °C	\sim	
~	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	А		
Ē	Reverse voltage	VR	3	V		\bigcirc
	Diode power dissipation	PD	100	mW	(7)	
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-1.0	mW/°C)
	Junction temperature	Tj	125	°C	$\langle () \rangle$	
	Forward current	lfd	50	μĄ		
ctor	Reverse voltage	Vrd	10	V (
Detector	Output power dissipation	Po	0.5	mW	\supset	2
	Junction temperature	Тј	125	((°C))	\Diamond	(
to	rage temperature range	T _{stg}	-55 to 125	್		$\overline{\ }$
)pe	erating temperature range	Topr	-40 to 85	°C	C	$\sum_{i=1}^{n}$
_ea 10	d soldering temperature s)	T _{sol}	260	°C))
	ation voltage ≿, 60 s, R.H. ≤ 60 %) (Note 1)	BVs	2500	Vrms		

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1, 2 and 3 shorted together, and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	\diamond	Symbol	Min	Тур.	Max	Unit
Forward current	$\mathcal{A}($	IF	_	20	25	mA
Operating temperature		T _{opr}	-25	_	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.2	1.4	1.7	V
LED	Reverse current	I _R	V _R = 3 V	_	_	10	μA
	Capacitance	Ст	V = 0V, f = 1 MHz	$\langle \rangle$	30	60	pF
ctor	Forward voltage	V _{FD}	I _{FD} = 10 μA		7	_	V
Detector	Reverse current	IRD	V _{RD} = 10 V))	1	_	nA

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min Typ.	Max	Unit
Open voltage	Voc	IF = 10 mA	7.0 8.0	-	V
Short current	Isc	IF = 10 mA	12 20	_	μA

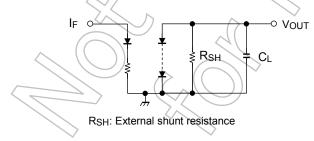
Isolation Characteristics (Ta = 25°C)

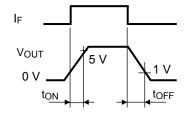
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	Cs	Vs = 0 V, f = 1 MHz	—	0.8	_	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation voltage	BVS	AC, 60 s	2500	—	_	Vrms

Switching Characteristics (Ta = 25°C)

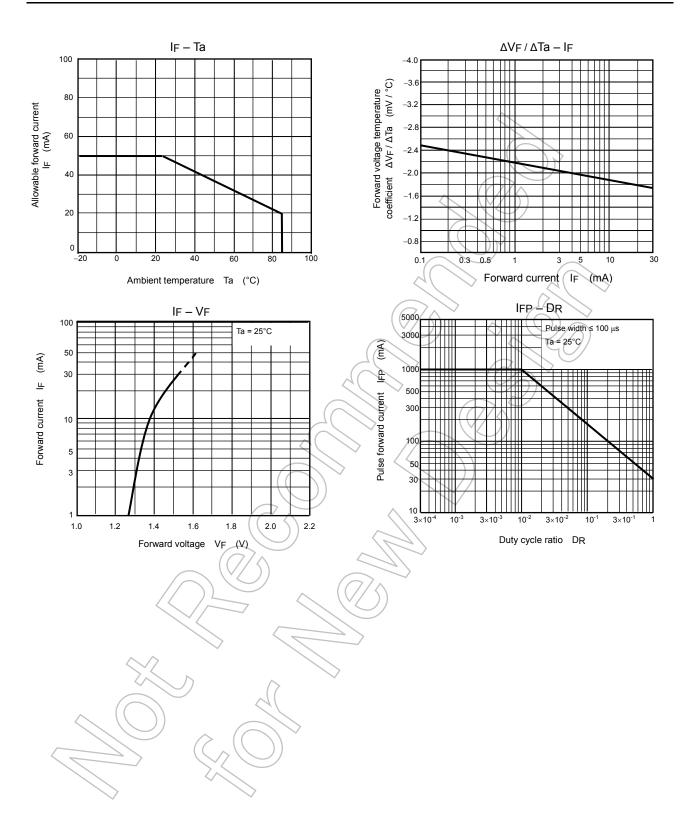
Chara	icteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time		ton	IF = 20 mA, RsH = 510 kΩ	_	0.2	_	ms
Turn-off time		TOFE	C⊾ =1000 pF (Note 2)		1		ms

Note 2: Switching time test circuit

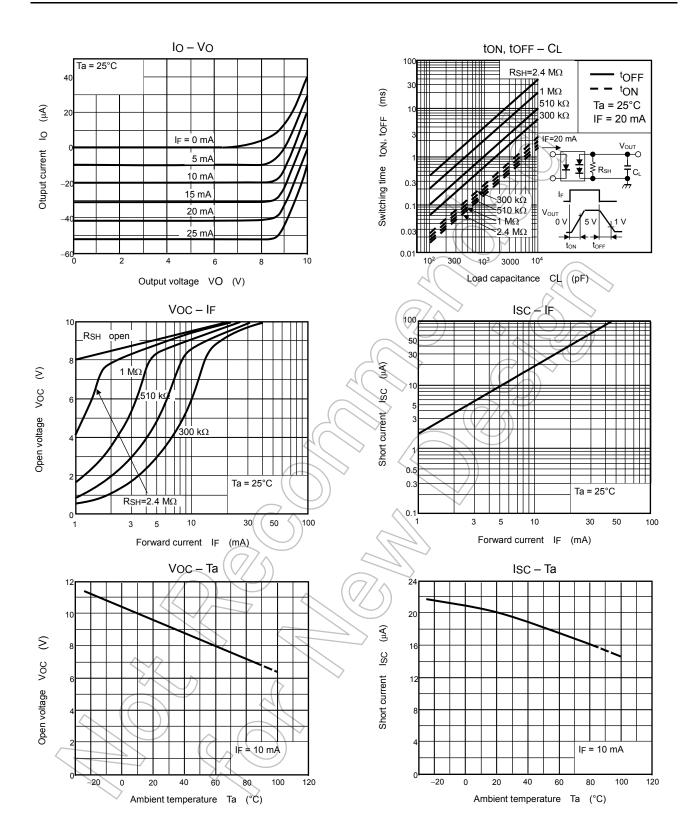




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NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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